

**AK09912****3-axis Electronic Compass****1. Features**

- A 3-axis electronic compass IC with high sensitive Hall sensor technology.
- Best adapted to pedestrian city navigation use for cell phone and other portable appliance.
- Functions:
 - 3-axis magnetometer device suitable for compass application
 - Built-in A to D Converter for magnetometer data out
 - 16-bit data out for each 3-axis magnetic component
 - Sensitivity: 0.15 μ T/LSB (typ.)
 - Serial interface
 - I²C bus interface
 - Standard, Fast and High-speed modes (up to 2.5 MHz) compliant with Philips I2C specification Ver.2.1
 - 4-wire SPI
 - Operation mode
 - Power-down, Single measurement, Continuous measurement, External trigger measurement, Self-test and Fuse ROM access
 - DRDY (Data Ready) function for measurement data ready
 - Magnetic sensor overflow monitor function
 - Built-in oscillator for internal clock source
 - Power on Reset circuit
 - Self test function with internal magnetic source
 - Built-in Noise Suppression Filter (NSF)
 - Built-in temperature sensor
- Operating temperatures:
 - -30°C to +85°C
- Operating supply voltage:
 - Analog power supply +1.7V to +3.6V
 - Digital Interface supply +1.65V to analog power supply voltage
- Current consumption:
 - Power-down: 3 μ A (typ.)
 - Measurement:
 - Average current consumption at 100 Hz repetition rate: 1 mA (typ.)
- Package:
 - AK09912C 14-pin WL-CSP (BGA): 1.6 mm × 1.6 mm × 0.5 mm (typ.)

2. Overview

AK09912 is 3-axis electronic compass IC with high sensitive Hall sensor technology.

Small package of AK09912 incorporates magnetic sensors for detecting terrestrial magnetism in the X-axis, Y-axis, and Z-axis, a sensor driving circuit, signal amplifier chain, and an arithmetic circuit for processing the signal from each sensor. Self test function is also incorporated. From its compact foot print and thin package feature, it is suitable for map heading up purpose in GPS-equipped cell phone to realize pedestrian navigation function.

AK09912 has the following features:

- (1) Silicon monolithic Hall-effect magnetic sensor with magnetic concentrator realizes 3-axis magnetometer on a silicon chip. Analog circuit, digital logic, power block and interface block are also integrated on a chip.
- (2) Wide dynamic measurement range and high resolution with lower current consumption.
 - Output data resolution: 16-bit (0.15 μ T/LSB)
 - Measurement range: $\pm 4900 \mu$ T
 - Average current at 100 Hz repetition rate: 1 mA (typ.)
- (3) Digital serial interface
 - I²C bus interface to control AK09912 functions and to read out the measured data by external CPU. A dedicated power supply for I²C bus interface can work in low-voltage apply as low as 1.65V.
 - 4-wire SPI is also supported. A dedicated power supply for SPI can work in low-voltage apply as low as 1.65V.
- (4) DRDY pin and register inform to system that measurement is end and set of data in registers are ready to be read.
- (5) Device is worked by on-chip oscillator so no external clock source is necessary.
- (6) Self test function with internal magnetic source to confirm magnetic sensor operation on end products.
- (7) Built-in NSF (Noise Suppression Filter) keeps magnetic sensor output stable.
- (8) Built-in temperature sensor to monitor the temperature while operation.

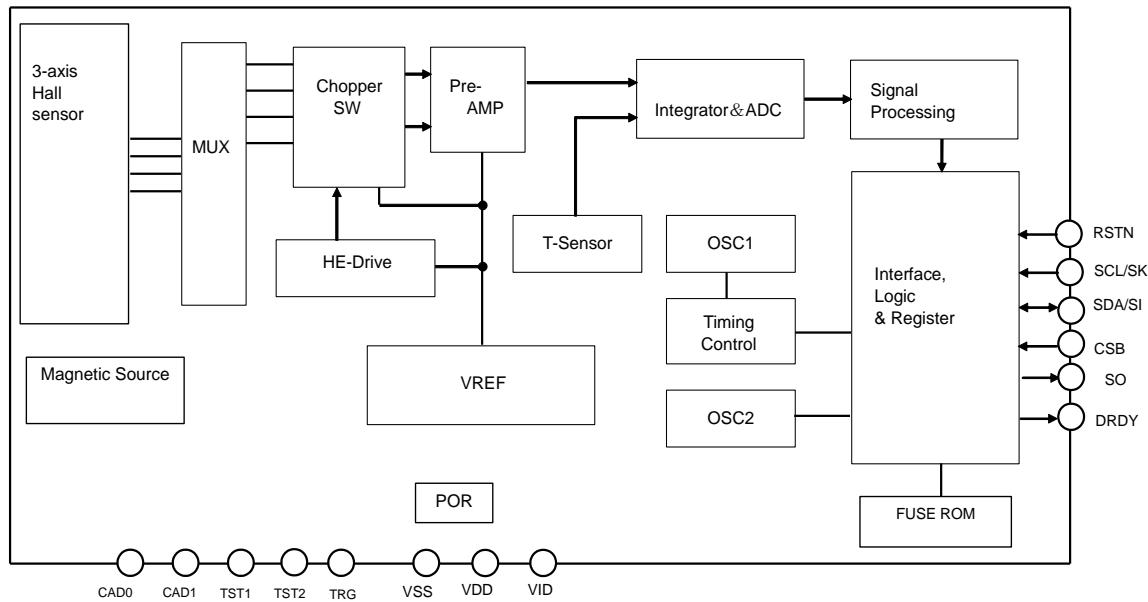
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4. Circuit Configuration

4.1. Block Diagram



4.2. Block Function

Block	Function
3-axis Hall sensor	Monolithic Hall elements.
MUX	Multiplexer for selecting Hall elements.
Chopper SW	Performs chopping.
HE-Drive	Magnetic sensor drive circuit for constant-current driving of sensor.
Pre-AMP	Fixed-gain differential amplifier used to amplify the magnetic sensor signal.
T-Sensor	Temperature sensor. Generate a voltage in proportion to temperature.
Integrator & ADC	Integrates and amplifies pre-AMP output or T-sensor output and performs analog-to-digital conversion.
OSC1	Generates an operating clock for sensor measurement.
OSC2	Generates an operating periodic clock for sequencer.
POR	Power On Reset circuit. Generates reset signal on rising edge of VDD.
VREF	Generates reference voltage and current.
Interface Logic & Register	Exchanges data with an external CPU. DRDY pin indicates sensor measurement has ended and data is ready to be read. I2C bus interface using two pins, namely, SCL and SDA. Standard, Fast and High-speed modes are supported. The low-voltage specification can be supported by applying 1.65V to the VID pin. 4-wire SPI is also supported by SK, SI, SO and CSB pins. 4-wire SPI works in VID pin voltage down to 1.65 V, too.
Signal Processing	Noise suppression function by the filtering process. Filtering process can be enabled or disabled.
Timing Control	Generates a timing signal required for internal operation from a clock generated by the OSC1.
Magnetic Source	Generates magnetic field for self test of magnetic sensor.
FUSE ROM	Fuse ROM for adjustment.

4.3. Pin Function

Pin No.	Pin name	I/O	Power supply	Type	Function
A1	DRDY	O	VID	CMOS	Data Ready output pin. “H” active. Informs measurement ended and data is ready to be read.
A2	CSB	I	VID	CMOS	Chip select pin for 4-wire SPI. “L” active. Connect to VID when selecting I2C bus interface.
A3	SCL	I	VID	CMOS	When the I2C bus interface is selected (CSB pin is connected to VID). SCL: Control clock input pin Input: Schmitt trigger
	SK				When the 4-wire SPI is selected. SK: Serial clock input pin.
A4	SDA	I/O	VID	CMOS	When the I2C bus interface is selected (CSB pin is connected to VID). SDA: Control data input/output pin Input: Schmitt trigger, Output: Open drain
	SI	I			When the 4-wire SPI is selected. SI: Serial data input pin
B1	VDD	-	-	Power	Positive power supply pin.
B3	TST2	O	VID	CMOS	Test pin. Connect to VSS or keep this pin non-connected.
B4	SO	O	VID	CMOS	When the I2C bus interface is selected (CSB pin is connected to VID) Hi-Z output. Keep this pin electrically non-connected.
					When the 4-wire SPI is selected. Serial data output pin
C1	VSS	-	-	Power	Ground pin
C2	TST1	I	VDD	CMOS	Test pin. Pulled down by 100kΩ internal resister. Keep this pin electrically non-connected or connect to VSS.
C3	TRG	I	VID	CMOS	External trigger pulse input pin. Enabled only in External trigger measurement mode. Pulled down by 100kΩ internal resister. When External trigger measurement mode is not in use, keep this pin electrically non-connected or connect to VSS.
C4	VID	-	-	Power	Digital interface positive power supply pin.
D1	CAD0	I	VDD	CMOS	When the I2C bus interface is selected (CSB pin is connected to VID) CAD0:Slave address 0 input pin Connect to VSS or VDD.
					When the 4-wire serial interface is selected. Connect to VSS.
D2	CAD1	I	VDD	CMOS	When the I2C bus interface is selected (CSB pin is connected to VID). CAD1:Slave address 1 input pin Connect to VSS or VDD.
					When the 4-wire serial interface is selected. Connect to VSS.
D4	RSTN	I	VID	CMOS	Reset pin. Resets registers by setting to “L”. Connect to VID when not in use.

5. Overall Characteristics

5.1. Absolute Maximum Ratings

Vss=0V

Parameter	Symbol	Min.	Max.	Unit
Power supply voltage (Vdd, Vid)	V+	-0.3	+4.3	V
Input voltage	VIN	-0.3	(V+) +0.3	V
Input current	IIN	-	±10	mA
Storage temperature	Tst	-40	+125	°C

(Note 1) If the device is used in conditions exceeding these values, the device may be destroyed.
Normal operations are not guaranteed in such exceeding conditions.

5.2. Recommended Operating Conditions

Vss=0V

Parameter	Remark	Symbol	Min.	Typ.	Max.	Unit
Operating temperature		Ta	-30		+85	°C
Power supply voltage	VDD pin voltage	Vdd	1.7	3.0	3.6	V
	VID pin voltage	Vid	1.65		Vdd	V

5.3. Electrical Characteristics

The following conditions apply unless otherwise noted:

Vdd=1.7V to 3.6V, Vid=1.65V to Vdd, Temperature range=-30 °C to 85 °C

5.3.1. DC Characteristics

Parameter	Symbol	Pin	Condition	Min.	Typ.	Max.	Unit
High level input voltage 1	VIH1	CSB RSTN TRG		70%Vid			V
Low level input voltage 1	VIL1					30%Vid	V
High level input voltage 2	VIH2	SK/SCL SI/SDA		70%Vid		Vid+0.3	V
Low level input voltage 2	VIL2			-0.3V		30%Vid	V
High level input voltage 3	VIH3	CAD0 CAD1 TST1		70%Vdd			V
Low level input voltage 3	VIL3					30%Vdd	V
Input current 1	IIN1	SK/SCL SI/SDA CSB RSTN	Vin=Vss or Vid	-10		+10	µA
			CAD0 CAD1	Vin=Vss or Vdd	-10	+10	
Input current 2	IIN2	TRG	Vin=Vid			100	µA
Input current 3	IIN3	TST1	Vin=Vdd			100	µA
Hysteresis input voltage (Note 2)	VHS	SCL SDA	Vid≥2V	5%Vid			V
			Vid<2V	10%Vid			
High level output voltage 1	VOH1	SO DRDY TST2	IOH≥-100µA	80%Vid			V
Low level output voltage 1	VOL1		IOL≤+100µA			20%Vid	V
Low level output voltage 2 (Note 3)	VOL2	SDA	IOL≤+3mA Vid≥2V			0.4	V
			IOL≤+3mA Vid<2V			20%Vid	V

Current consumption (Note 4)	IDD1	VDD VID	Power-down mode Vdd=Vid=3.0V		3	6	µA
	IDD2		When magnetic sensor is driven		1.4	2.3	mA
	IDD3		Self-test mode		3.4	5	mA
	IDD4		When temperature sensor is driven		1	1.5	mA
	IDD5		(Note 5)		0.1	5	µA

(Note 2) Schmitt trigger input (reference value for design)

(Note 3) Output is open-drain. Connect a pull-up resistor externally

(Note 4) Without any resistance load

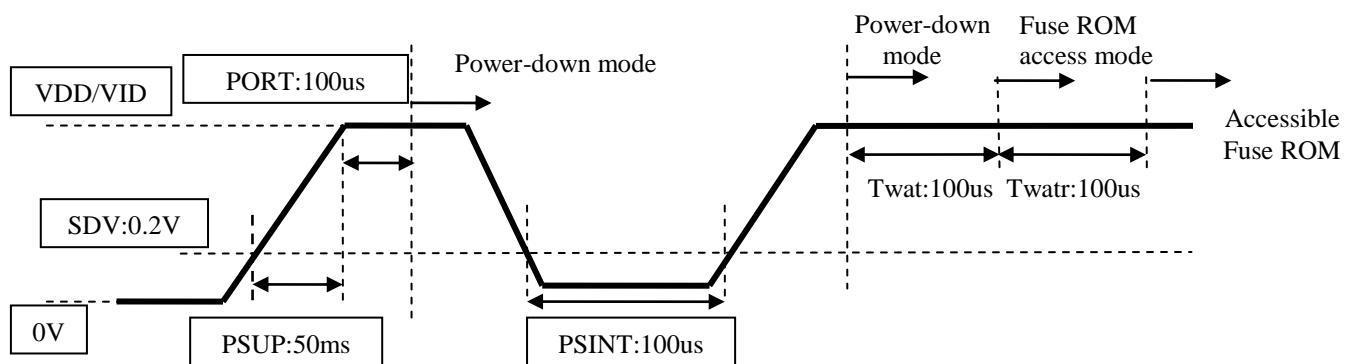
(Note 5) (case 1) Vdd=ON, Vid=ON, RSTN pin="L". (case 2) Vdd=ON, Vid=OFF (0V), RSTN pin="L". (case 3) Vdd=OFF (0V), Vid=ON.

5.3.2. AC Characteristics

Parameter	Symbol	Pin	Condition	Min.	Typ.	Max.	Unit
Power supply rise time (Note 6)	PSUP	VDD VID	Period of time that VDD (VID) changes from 0.2V to Vdd (Vid).			50	ms
POR completion time (Note 6)	PORT		Period of time after PSUP to Power-down mode (Note 7)			100	µs
Power supply turn off voltage (Note 6)	SDV	VDD VID	Turn off voltage to enable POR to restart (Note 7)			0.2	V
Power supply turn on interval (Note 6)	PSINT	VDD VID	Period of time that voltage lower than SDV needed to be kept to enable POR to restart (Note 7)	100			µs
Wait time before mode setting	Twat			100			µs
Wait time of Fuse ROM reading	Twatr		Wait time from Fuse ROM access mode setting to accessible Fuse ROM	100			µs

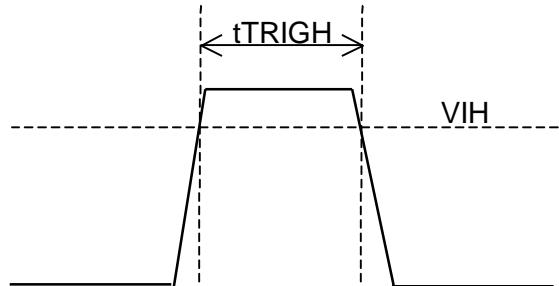
(Note 6) Reference value for design.

(Note 7) When POR circuit detects the rise of VDD/VID voltage, it resets internal circuits and initializes the registers.
After reset, AK09912 transits to Power-down mode.

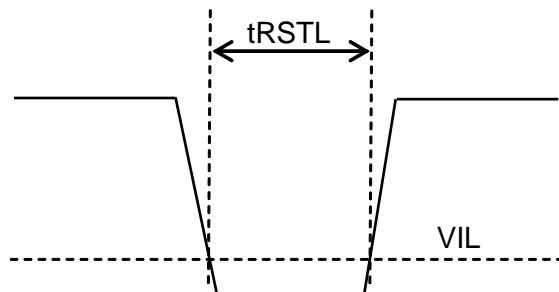


Parameter	Symbol	Pin	Condition	Min.	Typ.	Max.	Unit
Trigger input effective pulse width	tTRIGH	TRG		200			ns
Trigger input effective frequency (Note 8)	tTRIGf	TRG				100	Hz

(Note 8) The value when the period of time from the end of the measurement to the next trigger input is 1.3ms.



Parameter	Symbol	Pin	Condition	Min.	Typ.	Max.	Unit
Reset input effective pulse width ("L")	tRSTL	RSTN		5			μs



5.3.3. Analog Circuit Characteristics

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Measurement data output bit	DBIT		-	16	-	bit
Time for measurement	TSM	Single measurement mode		7.2	8.5	ms
Magnetic sensor sensitivity (Note 9)	BSE	$T_c = 25^\circ C$	0.1425	0.15	0.1575	μT/LSB
Magnetic sensor measurement range (Note 10)	BRG	$T_c = 25^\circ C$	±4912			μT
Magnetic sensor initial offset (Note 11)		$T_c = 25^\circ C$	-2000		+2000	LSB

(Note 9) Value after sensitivity is adjusted using sensitivity fine adjustment data stored in Fuse ROM.

(Note 10) Reference value for design

(Note 11) Value of measurement data register on shipment without applying magnetic field on purpose.

5.3.4. 4-wire SPI

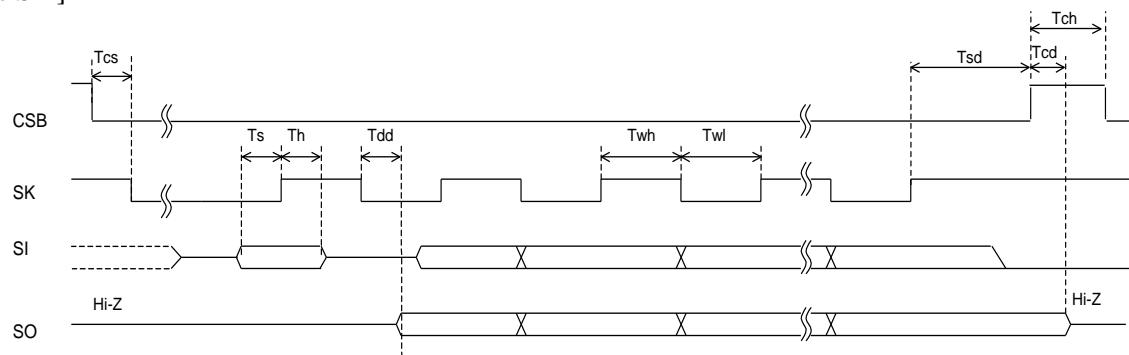
4-wire SPI is compliant with mode 3 (SPI-mode3).

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
CSB setup time	Tcs		50			ns
Data setup time	Ts		50			ns
Data hold time	Th		50			ns
SK high time	Twh	Vid \geq 2.5V	100			ns
		2.5V $>$ Vid \geq 1.65V	150			ns
SK low time	Twl	Vid \geq 2.5V	100			ns
		2.5V $>$ Vid \geq 1.65V	150			ns
SK setup time	Tsd		50			ns
SK to SO delay time (Note 12)	Tdd				50	ns
CSB to SO delay time (Note 12)	Tcd				50	ns
SK rise time (Note 13)	Tr				100	ns
SK fall time (Note 13)	Tf				100	ns
CSB high time	Tch		150			ns

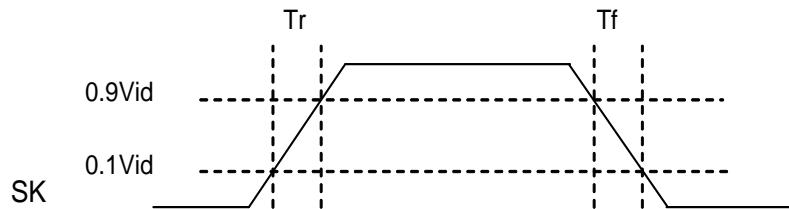
(Note 12) SO load capacitance:20pF

(Note 13) Reference value for design.

[4-wire SPI]



[Rise time and fall time]



5.3.5. I²C Bus Interface

CSB pin = "H"

I²C bus interface is compliant with Standard mode and Fast mode. Standard/Fast mode is selected automatically by fSCL.

Standard mode

fSCL≤100kHz

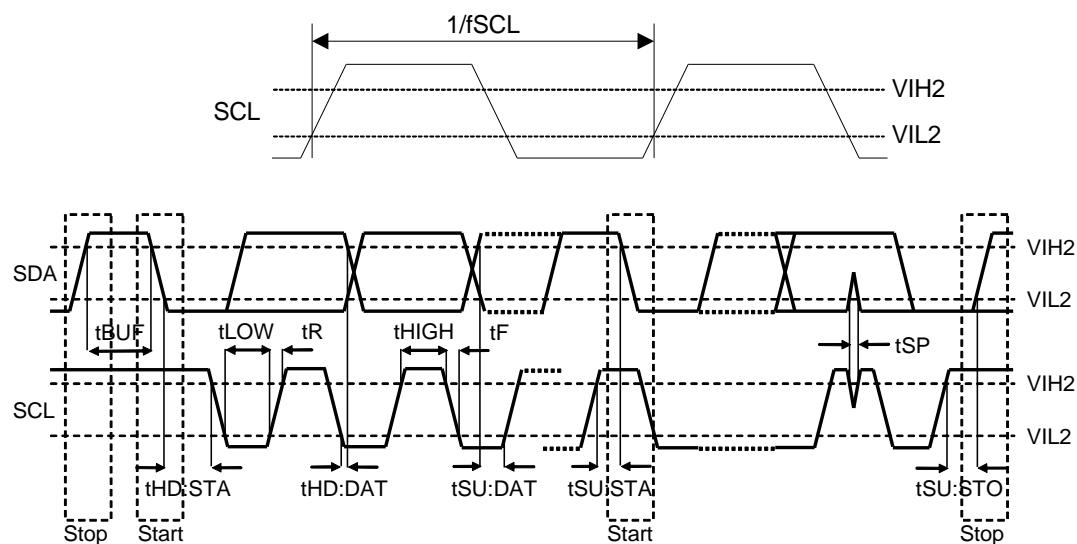
Symbol	Parameter	Min.	Typ.	Max.	Unit
fSCL	SCL clock frequency			100	kHz
tHIGH	SCL clock "High" time	4.0			μs
tLOW	SCL clock "Low" time	4.7			μs
tR	SDA and SCL rise time			1.0	μs
tF	SDA and SCL fall time			0.3	μs
tHD:STA	Start Condition hold time	4.0			μs
tSU:STA	Start Condition setup time	4.7			μs
tHD:DAT	SDA hold time (vs. SCL falling edge)	0			μs
tSU:DAT	SDA setup time (vs. SCL rising edge)	250			ns
tSU:STO	Stop Condition setup time	4.0			μs
tBUF	Bus free time	4.7			μs

Fast mode

100Hz≤fSCL≤400kHz

Symbol	Parameter	Min.	Typ.	Max.	Unit
fSCL	SCL clock frequency			400	kHz
tHIGH	SCL clock "High" time	0.6			μs
tLOW	SCL clock "Low" time	1.3			μs
tR	SDA and SCL rise time			0.3	μs
tF	SDA and SCL fall time			0.3	μs
tHD:STA	Start Condition hold time	0.6			μs
tSU:STA	Start Condition setup time	0.6			μs
tHD:DAT	SDA hold time (vs. SCL falling edge)	0			μs
tSU:DAT	SDA setup time (vs. SCL rising edge)	100			ns
tSU:STO	Stop Condition setup time	0.6			μs
tBUF	Bus free time	1.3			μs
tSP	Noise suppression pulse width			50	ns

[I²C bus interface timing]



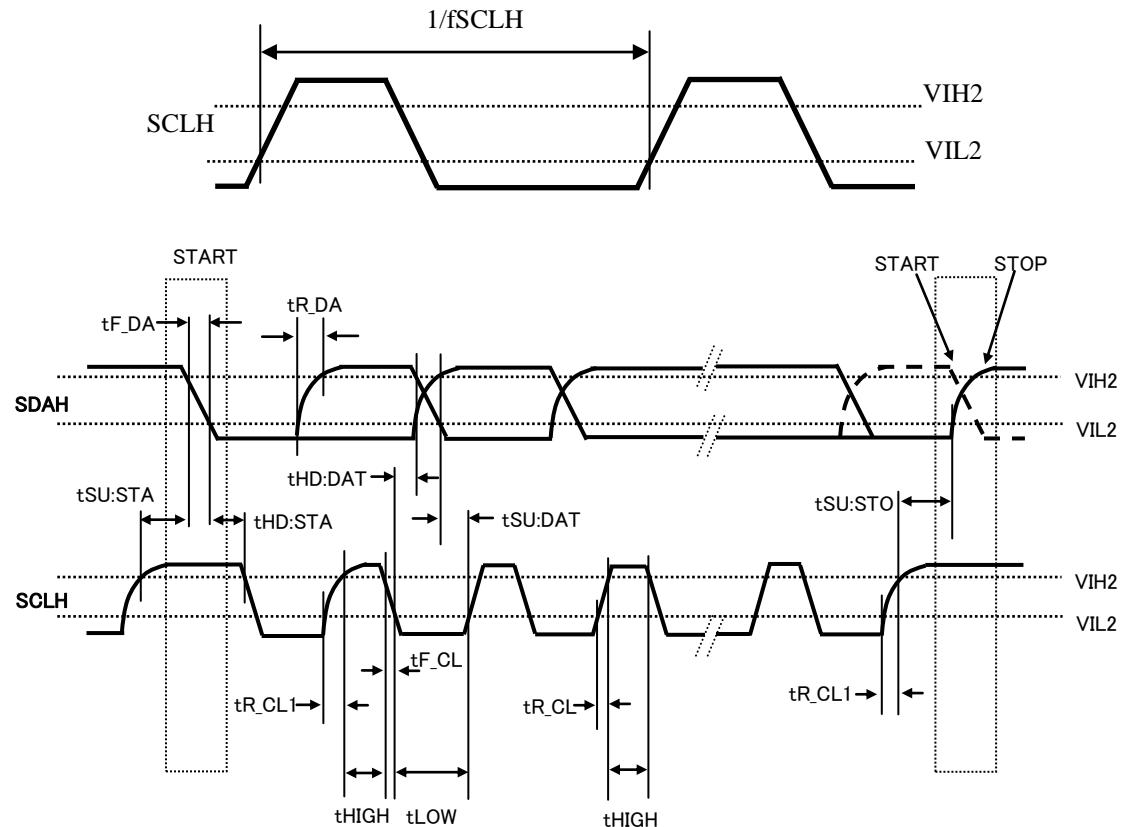
□ High-speed mode (Hs-mode)

➤ $C_b \leq 100\text{pF}$ (C_b : load capacitance)
 $f_{SCLH} \leq 2.5\text{MHz}$

Symbol	Parameter	Min.	Typ.	Max.	Unit
f_{SCLH}	SCLH clock frequency			2.5	MHz
t_{HIGH}	SCLH clock “High” time	110			ns
t_{LOW}	SCLH clock “Low” time	220			ns
t_{R_CL}	SCLH rise time	10		40	ns
t_{R_CL1}	SCLH rise time after a repeated START condition and after an acknowledge bit	10		80	ns
t_{R_DA}	SDAH rise time	10		80	ns
t_{F_CL}	SCLH fall time	-		40	ns
t_{F_DA}	SDAH fall time	-		80	ns
$t_{HD:STA}$	Start Condition hold time	160			ns
$t_{SU:STA}$	Start Condition setup time	160			ns
$t_{HD:DAT}$	SDAH hold time (vs. SCLH falling edge)	0			ns
$t_{SU:DAT}$	SDAH setup time (vs. SCLH rising edge)	10			ns
$t_{SU:STO}$	Stop Condition setup time	160			ns
t_{SP}	Noise suppression pulse width			10	ns

➤ $C_b \leq 400\text{pF}$
 $f_{SCLH} \leq 1.7\text{MHz}$

Symbol	Parameter	Min.	Typ.	Max.	Unit
f_{SCLH}	SCLH clock frequency			1.7	MHz
t_{HIGH}	SCLH clock “High” time	120			ns
t_{LOW}	SCLH clock “Low” time	320			ns
t_{R_CL}	SCLH rise time	20		80	ns
t_{R_CL1}	SCLH rise time after a repeated START condition and after an acknowledge bit	20		160	ns
t_{R_DA}	SDAH rise time	20		160	ns
t_{F_CL}	SCLH fall time	-		80	ns
t_{F_DA}	SDAH fall time	-		160	ns
$t_{HD:STA}$	Start Condition hold time	160			ns
$t_{SU:STA}$	Start Condition setup time	160			ns
$t_{HD:DAT}$	SDAH hold time (vs. SCLH falling edge)	0			ns
$t_{SU:DAT}$	SDAH setup time (vs. SCLH rising edge)	10			ns
$t_{SU:STO}$	Stop Condition setup time	160			ns
t_{SP}	Noise suppression pulse width			10	ns



6. Function Explanation

6.1. Power States

When VDD and VID are turned on from Vdd=OFF (0V) and Vid=OFF (0V), all registers in AK09912 are initialized by POR circuit and AK09912 transits to Power-down mode.

All the states in the table below can be set, although the transition from state 2 to state 3 and the transition from state 3 to state 2 are prohibited.

Table 6.1 Power state

State	VDD	VID	Power state
1	OFF (0V)	OFF (0V)	OFF (0V). It doesn't affect external interface. Digital input pins other than SCL and SDA pin should be fixed to "L" (0V).
2	OFF (0V)	1.65V to 3.6V	OFF (0V) It doesn't affect external interface.
3	1.7V to 3.6V	OFF (0V)	OFF(0V) It doesn't affect external interface. Digital input pins other than SCL and SDA pin should be fixed to "L" (0V).
4	1.7V to 3.6V	1.65V to Vdd	ON

6.2. Reset Functions

When the power state is ON, always keep Vid≤Vdd.

Power-on reset (POR) works until Vdd reaches to the operation effective voltage (about 1.1V: reference value for design) on power-on sequence. After POR is deactivated, all registers are initialized and transits to power down mode.

When Vdd=1.7 to 3.6V, POR circuit and VID monitor circuit are active. When Vid=0V, AK09912 is in reset status and it consumes the current of reset state (IDD5).

AK09912 has four types of reset;

- (1) Power on reset (POR)
When Vdd rise is detected, POR circuit operates, and AK09912 is reset.
- (2) VID monitor
When VID is turned OFF (0V), AK09912 is reset.
- (3) Reset pin (RSTN)
AK09912 is reset by Reset pin. When Reset pin is not used, connect to VID.
- (4) Soft reset
AK09912 is reset by setting SRST bit. When AK09912 is reset, all registers (without ASAX, ASAY and ASAZ) are initialized and AK09912 transits to Power-down mode.

6.3. Operation Mode

AK09912 has following nine operation modes:

- (1) Power-down mode
- (2) Single measurement mode
- (3) Continuous measurement mode 1
- (4) Continuous measurement mode 2
- (5) Continuous measurement mode 3
- (6) Continuous measurement mode 4
- (7) External trigger measurement mode
- (8) Self-test mode
- (9) Fuse ROM access mode

By setting CNTL2 register MODE[4:0] bits, the operation set for each mode is started.

A transition from one mode to another is shown below.

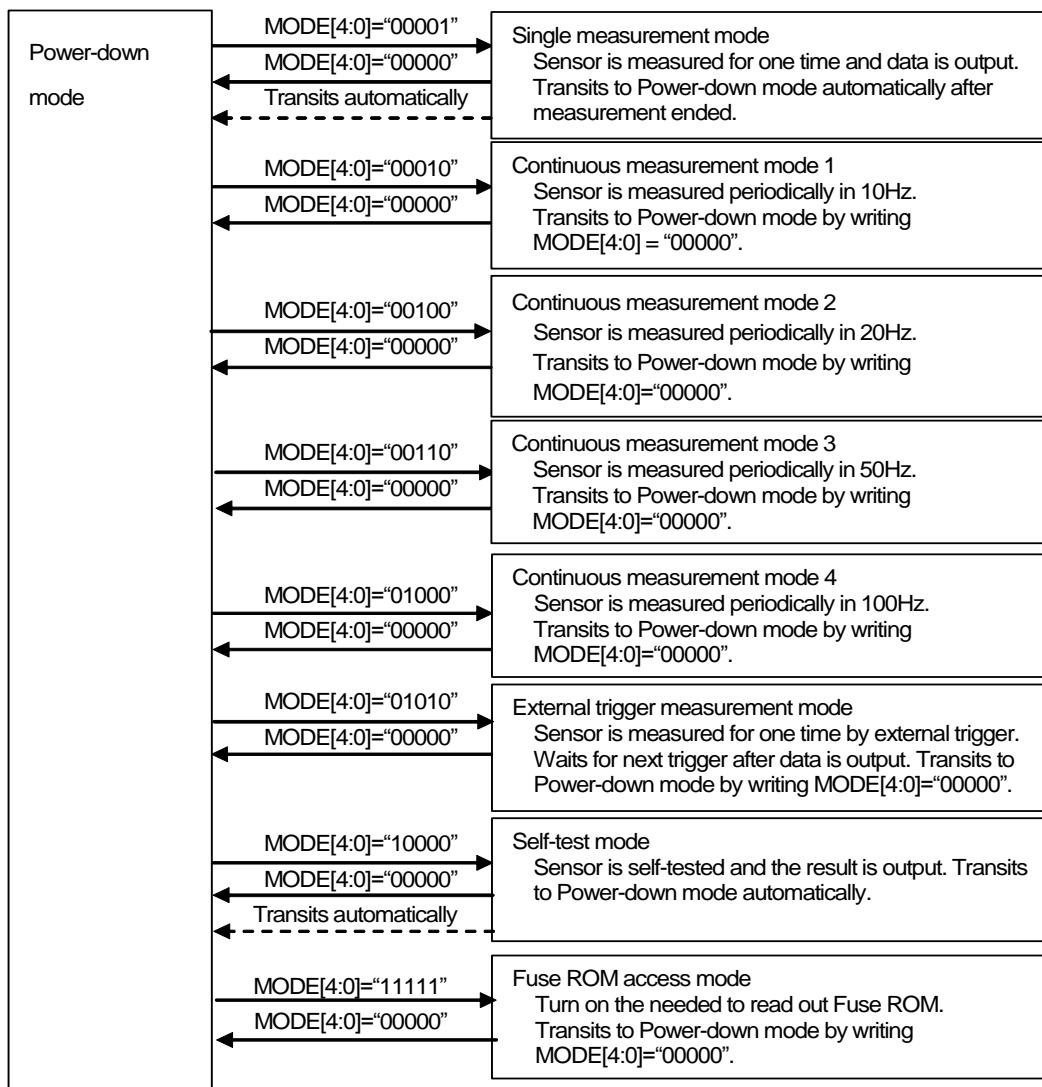


Figure 6.1 Operation mode

When power is turned ON, AK09912 is in Power-down mode. When a specified value is set to MODE[4:0], AK09912 transits to the specified mode and starts operation. When user wants to change operation mode, transit to power-down mode first and then transit to other modes. After Power-down mode is set, at least 100 μ s (Twat) is needed before setting another mode.

6.4. Description of Each Operation Mode

6.4.1. Power-down Mode

Power to almost all internal circuits is turned off. All registers are accessible in Power-down mode. Data stored in read/write registers are remained. They can be reset by soft reset.

6.4.2. Single Measurement Mode

When Single measurement mode (MODE[4:0] = "00001") is set, magnetic sensor measurement is started. After magnetic sensor measurement and signal processing is finished, measurement magnetic data is stored to measurement data registers (HXL to HZH), then AK09912 transits to Power-down mode automatically. On transition to Power-down mode, MODE[4:0] turns to "00000". When temperature sensor is enabled (TEM = "1"), temperature sensor measurement is started together with magnetic sensor measurement and measurement temperature data is stored to measurement data registers (TMPS). At the same time, DRDY bit in ST1 register turns to "1". This is called "Data Ready". When any of measurement data register (HXL to TMPS) or ST2 register is read, DRDY bit turns to "0". It remains "1" on transition from Power-down mode to another mode. DRDY pin is in the same state as DRDY bit. (Figure 6.2)

When sensor is measuring (Measurement period), measurement data registers (HXL to TMPS) keep the previous data. Therefore, it is possible to read out data even in measurement period. Data read out in measurement period are previous data. (Figure 6.3)

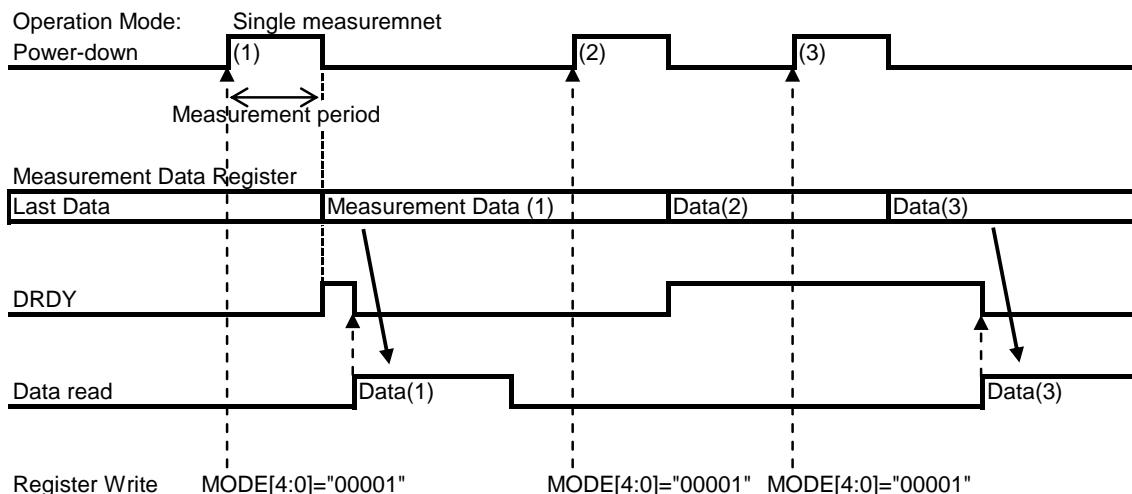


Figure 6.2 Single measurement mode when data is read out of measurement period

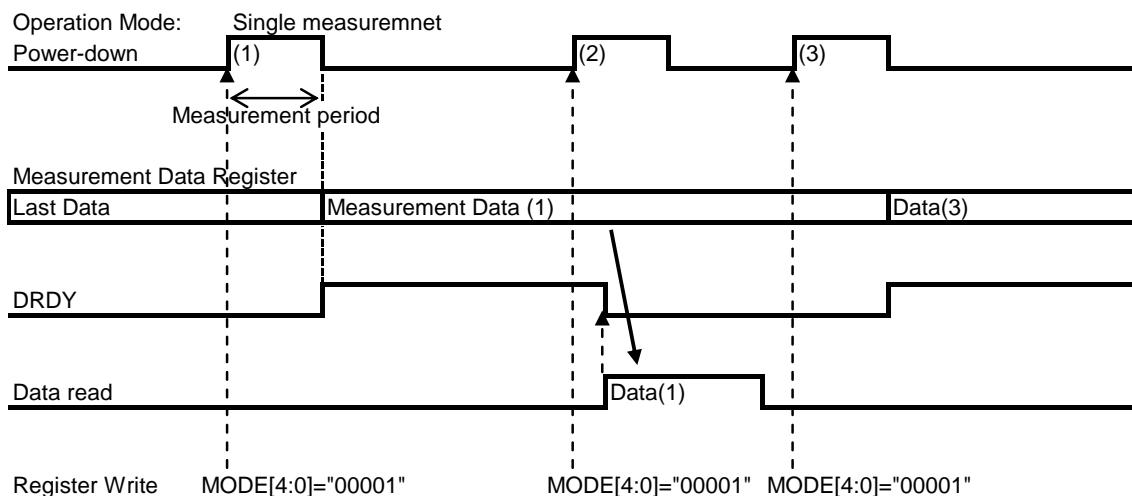


Figure 6.3 Single measurement mode when data read started during measurement period

6.4.3. Continuous Measurement Mode 1, 2, 3 and 4

When Continuous measurement mode 1 (MODE[4:0] = “00010”), 2 (MODE[4:0] = “00100”), 3 (MODE[4:0] = “00110”) or 4 (MODE[4:0] = “01000”) is set, magnetic sensor measurement is started periodically at 10 Hz, 20 Hz, 50 Hz or 100 Hz respectively. After magnetic sensor measurement and signal processing is finished, measurement magnetic data is stored to measurement data registers (HXL to HZH) and all circuits except for the minimum circuit required for counting cycle length are turned off (PD). When the next measurement timing comes, AK09912 wakes up automatically from PD and starts measurement again. When temperature sensor is enabled (TEM = “1”), temperature sensor measurement is started together with magnetic sensor measurement, and measurement temperature data is stored to measurement data registers (TMPS).

Continuous measurement mode ends when Power-down mode (MODE[4:0] = “00000”) is set. It repeats measurement until Power-down mode is set.

When Continuous measurement mode 1 (MODE[4:0] = “00010”), 2 (MODE[4:0] = “00100”), 3 (MODE[4:0] = “00110”) or 4 (MODE[4:0] = “01000”) is set again while AK09912 is already in Continuous measurement mode, a new measurement starts. ST1, ST2 and measurement data registers (HXL to TMPS) will not be initialized by this.

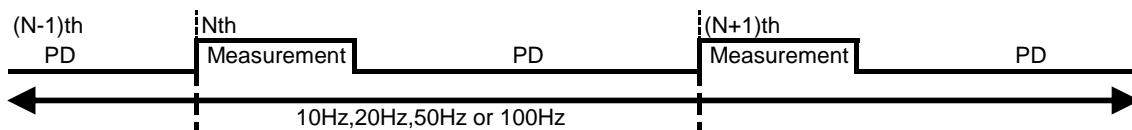


Figure 6.4 Continuous measurement mode

6.4.3.1. Data Ready

When measurement data is stored and ready to be read, DRDY bit in ST1 register turns to “1”. This is called “Data Ready”. DRDY pin is in the same state as DRDY bit. When measurement is performed correctly, AK09912 becomes Data Ready on transition to PD after measurement.

6.4.3.2. Normal Read Sequence

- (1) Check Data Ready or not by any of the following method.
 - Polling DRDY bit of ST1 register
 - Monitor DRDY pin
 When Data Ready, proceed to the next step.
- (2) Read ST1 register (not needed when polling ST1)
 - DRDY: Shows Data Ready or not. Not when “0”, Data Ready when “1”.
 - DOR: Shows if any data has been skipped before the current data or not. There are no skipped data when “0”, there are skipped data when “1”.
- (3) Read measurement data
 When any of measurement data register (HXL to TMPS) or ST2 register is read, AK09912 judges that data reading is started. When data reading is started, DRDY bit and DOR bit turns to “0”.
- (4) Read ST2 register (required)
 - HOFL: Shows if magnetic sensor is overflowed or not. “0” means not overflowed, “1” means overflowed.
 When ST2 register is read, AK09912 judges that data reading is finished. Stored measurement data is protected during data reading and data is not updated. By reading ST2 register, this protection is released. It is required to read ST2 register after data reading.

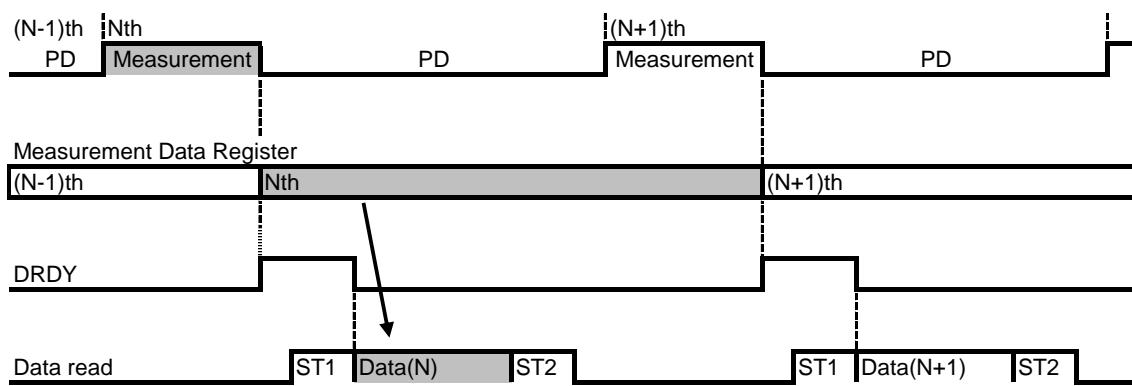


Figure 6.5 Normal read sequence

6.4.3.3. Data Read Start during Measurement

When sensor is measuring (Measurement period), measurement data registers (HXL to TMPS) keep the previous data. Therefore, it is possible to read out data even in measurement period. If data is started to be read during measurement period, previous data is read.

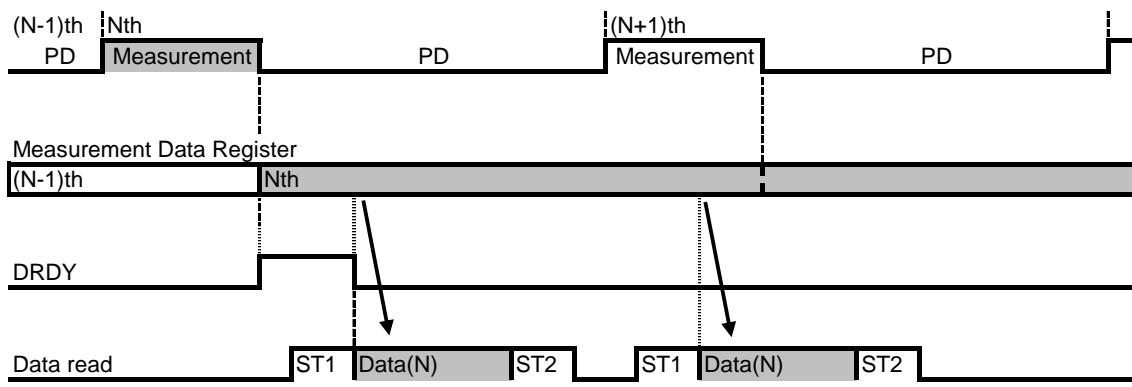


Figure 6.6 Data read start during measurement

6.4.3.4. Data Skip

When Nth data was not read before (N+1)th measurement ends, Data Ready remains until data is read. In this case, a set of measurement data is skipped so that DOR bit turns to “1”.

When data reading started after Nth measurement ended and did not finish reading before (N+1)th measurement ended, Nth measurement data is protected to keep correct data. In this case, a set of measurement data is skipped and not stored so that DOR bit turns to “1”.

In both case, DOR bit turns to “0” at the next start of data reading.

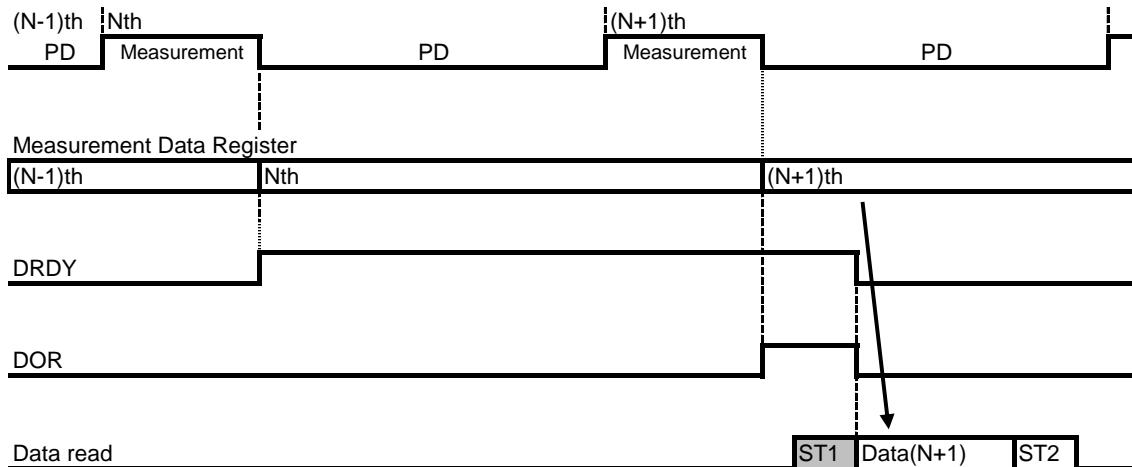


Figure 6.7 Data Skip: When data is not read

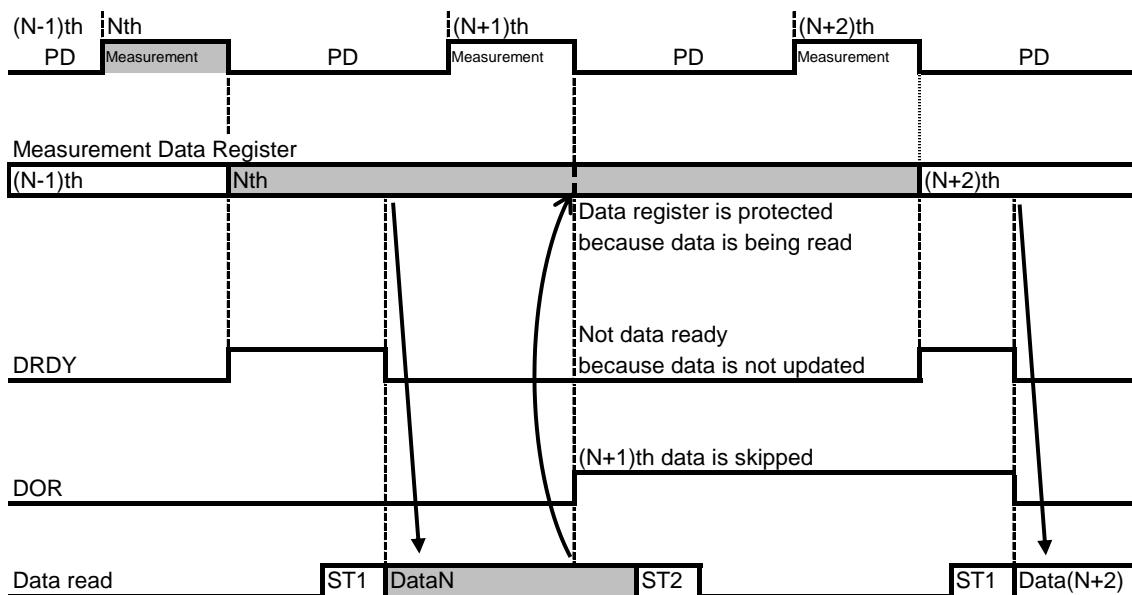


Figure 6.8 Data Skip: When data read has not been finished before the next measurement end

6.4.3.5. End Operation

Set Power-down mode (MODE[4:0] = “00000”) to end Continuous measurement mode.

6.4.3.6. Magnetic Sensor Overflow

AK09912 has the limitation for measurement range that the sum of absolute values of each axis should be smaller than 4912 μT .

$$|X| + |Y| + |Z| < 4912 \mu\text{T}$$

When the magnetic field exceeded this limitation, data stored at measurement data are not correct. This is called Magnetic Sensor Overflow.

When magnetic sensor overflow occurs, HOFL bit turns to “1”. When the next measurement starts, it returns to “0”.

6.4.4. External Trigger Measurement Mode

When External trigger measurement mode (MODE[4:0] = “01010”) is set, AK09912 waits for trigger input. When a pulse is input from TRG pin, magnetic sensor measurement is started on the rising edge of TRG pin. After magnetic sensor measurement and signal processing is finished, measurement magnetic data is stored to measurement data registers (HXL to HZH) and all circuits except for the minimum circuit required for trigger input waiting are turned off (PD state). When the next pulse is input, AK09912 wakes up automatically from PD and starts measurement again.

When temperature sensor is enabled (TEM = “1”), temperature sensor measurement is started together with magnetic sensor measurement, and measurement temperature data is stored to measurement data registers (TMPS).

When power-down mode (MODE[4:0] = “00000”) is set, External trigger measurement mode ends. AK09912 keeps waiting for the trigger input until the Power-down mode is set.

When External trigger measurement mode (MODE[4:0] = “01010”) is set again while AK09912 is already in External trigger measurement mode, it starts to wait for the trigger input again. The trigger input is ignored while sensor is measuring.

Data read sequence and functions of read-only registers in External trigger measurement mode are the same as Continuous measurement mode.

6.4.5. Self-test Mode

Self-test mode is used to check if the magnetic sensor is working normally.

When Self-test mode (MODE[4:0] = “10000”) is set, magnetic field is generated by the internal magnetic source and magnetic sensor is measured. Measurement data is stored to measurement data registers (HXL to HZH), then AK09912 transits to Power-down mode automatically.(Temperature sensor is not measured.)

Data read sequence and functions of read-only registers in Self-test mode are the same as Single measurement mode.

6.4.5.1. Self-test Sequence

- (1) Set Power-down mode. (MODE[4:0] = “00000”)
- (2) Set Self-test mode. (MODE[4:0] = “10000”)
- (3) Check Data Ready or not by any of the following method.
 - Polling DRDY bit of ST1 register
 - Monitor DRDY pin

When Data Ready, proceed to the next step.

- (4) Read measurement data (HXL to HZH)

6.4.5.2. Self-test Judgment

When measurement data read by the above sequence is in the range of following table after sensitivity adjustment (refer to 8.3.13), AK09912 is working normally.

	HX[15:0]	HY[15:0]	HZ[15:0]
Criteria	$-200 \leq \text{HX} \leq +200$	$-200 \leq \text{HY} \leq +200$	$-1600 \leq \text{HZ} \leq -400$

6.4.6. Fuse ROM Access Mode

Fuse ROM access mode is used to read Fuse ROM data. Sensitivity adjustment data for each axis is stored in Fuse ROM. Set Fuse ROM Access mode (MODE[4:0] = “11111”) before reading Fuse ROM data. When Fuse ROM Access mode is set, circuits required for reading Fuse ROM are turned on. However, it needs 100 μs (Twatr) to read Fuse ROM after mode setting.

After reading Fuse ROM data, set Power-down mode (MODE[4:0] = “00000”) before the transition to another mode.

6.5. Temperature Sensor

In Single measurement mode, Continuous measurement mode 1, 2, 3, 4, or External trigger measurement mode is set, AK09912 can measure temperature sensor together with magnetic sensor. When temperature sensor is enabled (TEM =“1”), temperature sensor measurement is started together with magnetic sensor measurement. In Continuous measurement mode 1, 2, 3 or 4, temperature sensor measurement is started at every 8 measurements of magnetic sensor measurement. In Single measurement mode or External trigger measurement mode, temperature sensor measurement is started at every measurement of magnetic sensor measurement. When user wants to change temperature sensor measurement enables or disables, set to Power-down mode is required before change temperature sensor measurement.

Default TEM register is “disable” (TEM=“0”).

6.6. Noise Suppression Filter (NSF)

In Single measurement mode, Continuous measurement mode 1, 2, 3, 4 or External trigger measurement mode, output from the magnetic sensor can be filtered to suppress the noise. This filter name is Noise Suppression Filter (NSF). There are three optional filter extents. When NSF[1:0]=“00”, NSF is “disable” and output magnetic data is not filtered. When NSF[1:0]=“01”, NSF extent is “Low” and output magnetic data is filtered mildly. When NSF[1:0]=“10”, NSF extent is “Middle” and output magnetic data is filtered moderately. When NSF[1:0]=“11”, NSF extent is “High” and output magnetic data is filtered strongly.

NSF register can be changed in Power-down mode only.

Default NSF register is “disable” (NSF[1:0]=“00”).

7. Serial Interface

AK09912 supports I²C bus interface and 4-wire SPI. A selection is made by CSB pin. When used as 3-wire SPI, set SI pin and SO pin wired-OR externally.

CSB pin="L": 4-wire SPI
CSB pin="H": I2C bus interface

7.1. 4-wire SPI

The 4-wire SPI consists of four digital signal lines: SK, SI, SO, and CSB, and is provided in 16bit protocol. Data consists of Read/Write control bit (R/W), register address (7-bit) and control data (8-bit). To read out all axes measurement data (X, Y, Z), an option to read out more than one byte data using automatic increment command is available. (Sequential read operation)

CSB pin is low active. Input data is taken in on the rising edge of SK pin, and output data is changed on the falling edge of SK pin. (SPI-mode3)

Communication starts when CSB pin transits to "L" and stops when CSB pin transits to "H". SK pin must be "H" during CSB pin is in transition. Also, it is prohibited to change SI pin during CSB pin is "H" and SK pin is "H".

7.1.1. Writing Data

Input 16 bits data on SI pin in synchronous with the 16-bit serial clock input on SK pin. Out of 16 bits input data, the first 8 bits specify the R/W control bit (R/W="0" when writing) and register address (7-bit), and the latter 8 bits are control data (8-bit). When any of addresses listed on Table 8.1 is input, AK09912 recognizes that it is selected and takes in latter 8 bits as setting data.

If the number of clock pulses is less than 16, no data is written. If the number of clock pulses is more than 16, data after the 16th clock pulse on SI pin are ignored.

It is not compliant with serial write operation for multiple addresses.

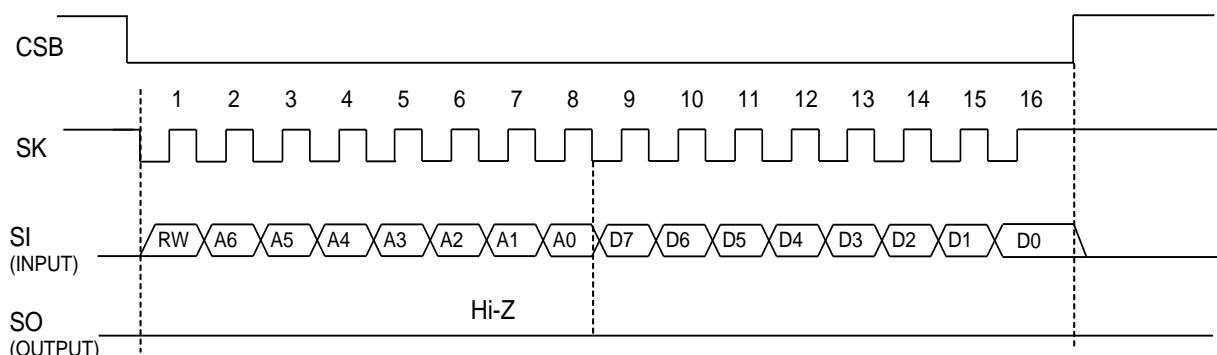


Figure 7.1 4-wire SPI Writing Data

7.1.2. Reading Data

Input the R/W control bit (R/W="1") and 7-bit register address on SI pin in synchronous with the first 8 bits of the 16 bits of a serial clock input on SK pin. Then AK09912 outputs the data held in the specified register with MSB first from SO pin. When clocks are input continuously after one byte of data is read, the address is incremented and data in the next address is output. Accordingly, after the falling edge of the 15th clock and CSB pin is "L", the data in the next address is output on SO pin. When CSB pin is driven "L" to "H", SO pin is placed in the high-impedance state.

AK09912 has two incrimination lines; 00H to 18H and 30H to 32H. For example, data is read as follows: 00H → 01H → 02H → 03H → 10H → 11H ... → 18H → 00H → 01H ..., 30H → 31H → 32H → 30H ..., or 60H → 61H → 62H → 60H

...
33H to 35H and 37H are reserved addresses. Do not access to those addresses.

When specified address is other than 00H to 18H, 30H to 37H and 60H to 62H, AK09912 recognizes that it is not selected and keeps SO pin in high-impedance state. Therefore, user can use other addresses for other devices.

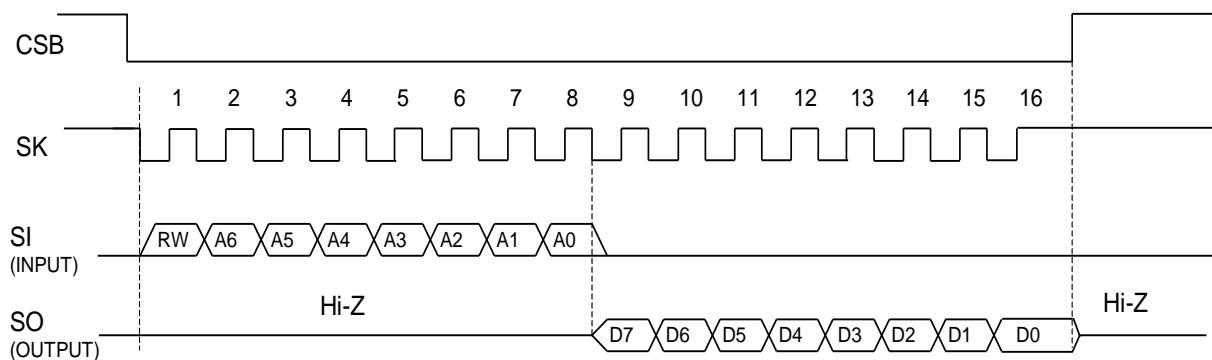


Figure 7.2 4-wire SPI Reading Data

7.2. I²C Bus Interface

The I²C bus interface of AK09912 supports the Standard mode (100 kHz max.), the Fast mode (400 kHz max.) and High-speed mode (Hs-mode, 2.5 MHz max.).

7.2.1. Data Transfer

To access AK09912 on the bus, generate a start condition first.

Next, transmit a one-byte slave address including a device address. At this time, AK09912 compares the slave address with its own address. If these addresses match, AK09912 generates an acknowledgement, and then executes READ or WRITE instruction. At the end of instruction execution, generate a stop condition.

7.2.1.1. Change of Data

A change of data on the SDA line must be made during “Low” period of the clock on the SCL line. When the clock signal on the SCL line is “High”, the state of the SDA line must be stable. (Data on the SDA line can be changed only when the clock signal on the SCL line is “Low”.)

During the SCL line is “High”, the state of data on the SDA line is changed only when a start condition or a stop condition is generated.

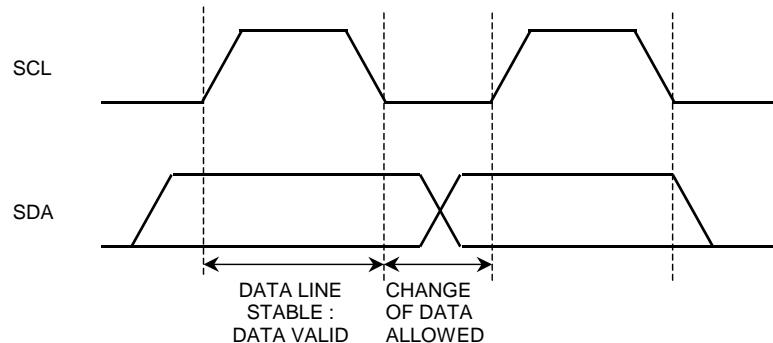


Figure 7.3 Data Change

7.2.1.2. Start/Stop Condition

If the SDA line is driven to “Low” from “High” when the SCL line is “High”, a start condition is generated. Every instruction starts with a start condition.

If the SDA line is driven to “High” from “Low” when the SCL line is “High”, a stop condition is generated. Every instruction stops with a stop condition.

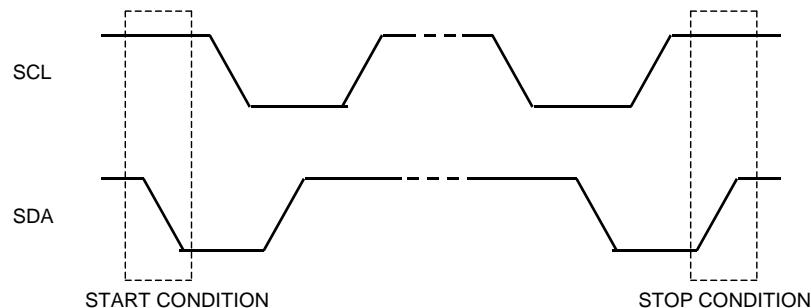


Figure 7.4 Start and Stop Condition

7.2.1.3. Acknowledge

The IC that is transmitting data releases the SDA line (in the “High” state) after sending 1-byte data.

The IC that receives the data drives the SDA line to “Low” on the next clock pulse. This operation is referred as acknowledge. With this operation, whether data has been transferred successfully can be checked.

AK09912 generates an acknowledge after reception of a start condition and slave address.

When a WRITE instruction is executed, AK09912 generates an acknowledge after every byte is received.

When a READ instruction is executed, AK09912 generates an acknowledge then transfers the data stored at the specified address. Next, AK09912 releases the SDA line then monitors the SDA line. If a master IC generates an acknowledge instead of a stop condition, AK09912 transmits the 8-bit data stored at the next address. If no acknowledge is generated, AK09912 stops data transmission.

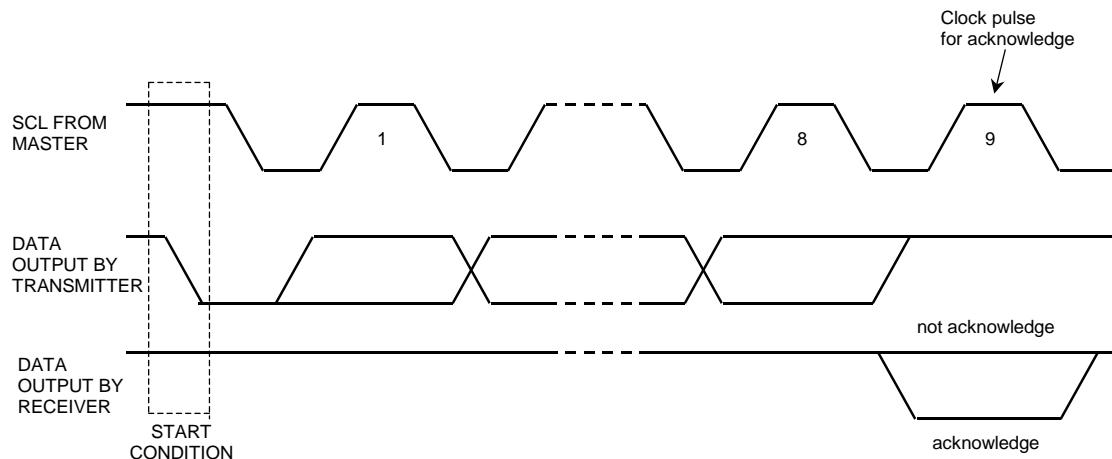


Figure 7.5 Generation of Acknowledge

7.2.1.4. Slave Address

The slave address of AK09912 can be selected from the following list by setting CAD0/1 pin. When CAD pin is fixed to VSS, the corresponding slave address bit is “0”. When CAD pin is fixed to VDD, the corresponding slave address bit is “1”.

Table 7.1 Slave Address and CAD0/1 pin

CAD1	CAD0	Slave Address
0	0	0CH
0	1	0DH
1	0	0EH
1	1	0FH

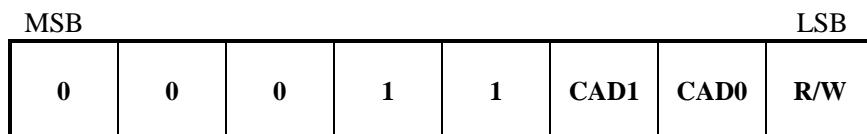


Figure 7.6 Slave Address

The first byte including a slave address is transmitted after a start condition, and an IC to be accessed is selected from the ICs on the bus according to the slave address.

When a slave address is transferred, the IC whose device address matches the transferred slave address generates an acknowledge then executes an instruction. The 8th bit (least significant bit) of the first byte is a R/W bit.

When the R/W bit is set to “1”, READ instruction is executed. When the R/W bit is set to “0”, WRITE instruction is executed.

7.2.2. WRITE Instruction

When the R/W bit is set to “0”, AK09912 performs write operation.

In write operation, AK09912 generates an acknowledge after receiving a start condition and the first byte (slave address) then receives the second byte. The second byte is used to specify the address of an internal control register and is based on the MSB-first configuration.

MSB								LSB							
A7	A6	A5	A4	A3	A2	A1	A0								

Figure 7.7 Register Address

After receiving the second byte (register address), AK09912 generates an acknowledge then receives the third byte. The third and the following bytes represent control data. Control data consists of 8 bits and is based on the MSB-first configuration. AK09912 generates an acknowledge after every byte is received. Data transfer always stops with a stop condition generated by the master.

MSB								LSB							
D7	D6	D5	D4	D3	D2	D1	D0								

Figure 7.8 Control Data

AK09912 can write multiple bytes of data at a time.

After reception of the third byte (control data), AK09912 generates an acknowledge then receives the next data. If additional data is received instead of a stop condition after receiving one byte of data, the address counter inside the LSI chip is automatically incremented and the data is written at the next address.

The address is incremented from 00H to 18H, from 30H to 32H, or from 60H to 62H. When the address is between 00H and 18H, the address is incremented 00H → 01H → 02H → 03H → 10H → 11H ... → 18H, and the address goes back to 00H after 18H. When the address is between 30H and 32H, the address goes back to 30H after 32H. When the address is between 60H and 62H, the address goes back to 60H after 62H.

Actual data is written only to Read/Write registers (refer to Table 8.2)

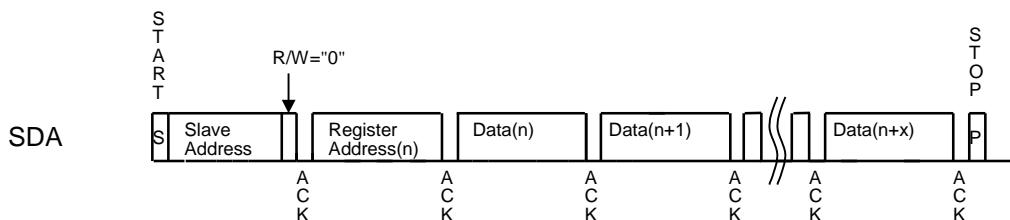


Figure 7.9 WRITE Instruction

7.2.3. READ Instruction

When the R/W bit is set to "1", AK09912 performs read operation.

If a master IC generates an acknowledge instead of a stop condition after AK09912 transfers the data at a specified address, the data at the next address can be read.

Address can be 00H to 18H, 30H to 32H, and 60H to 62H. When the address is between 00H and 18H, the address is incremented 00H → 01H → 02H → 03H → 10H → 11H ... → 18H, and the address goes back to 00H after 18H. When the address is between 30H and 32H, the address goes back to 30H after 32H. When the address is between 60H and 62H, the address goes back to 60H after 62H.

AK09912 supports one byte read and multiple bytes read.

7.2.3.1. One Byte READ

AK09912 has an address counter inside the LSI chip. In current address read operation, the data at an address specified by this counter is read.

The internal address counter holds the next address of the most recently accessed address.

For example, if the address most recently accessed (for READ instruction) is address "n", and a current address read operation is attempted, the data at address "n+1" is read.

In one byte read operation, AK09912 generates an acknowledge after receiving a slave address for the READ instruction (R/W bit="1"). Next, AK09912 transfers the data specified by the internal address counter starting with the next clock pulse, then increments the internal counter by one. If the master IC generates a stop condition instead of an acknowledge after AK09912 transmits one byte of data, the read operation stops.

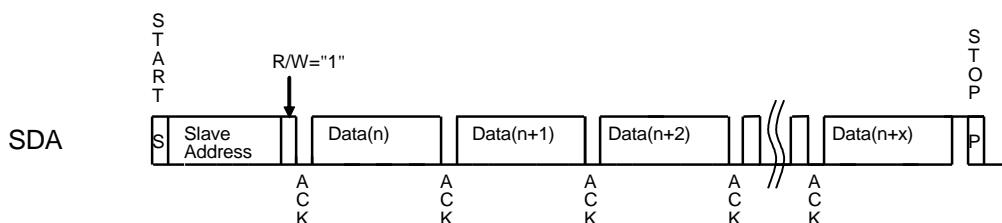


Figure 7.10 One Byte READ

7.2.3.2. Multiple Byte READ

By multiple byte read operation, data at an arbitrary address can be read.

The multiple byte read operation requires to execute WRITE instruction as dummy before a slave address for the READ instruction (R/W bit="1") is transmitted. In random read operation, a start condition is first generated then a slave address for the WRITE instruction (R/W bit="0") and a read address are transmitted sequentially.

After AK09912 generates an acknowledge in response to this address transmission, a start condition and a slave address for the READ instruction (R/W bit="1") are generated again. AK09912 generates an acknowledge in response to this slave address transmission. Next, AK09912 transfers the data at the specified address then increments the internal address counter by one. If the master IC generates a stop condition instead of an acknowledge after data is transferred, the read operation stops.

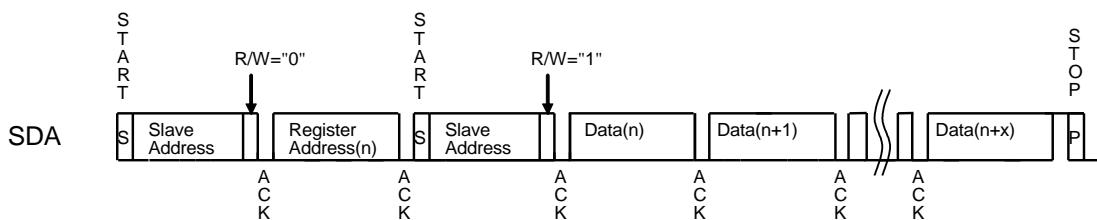


Figure 7.11 Multiple Byte READ

7.3. High-speed Mode (Hs-mode)

AK09912 supports the Hs-mode.

Hs-mode can only commence after the following conditions (all of which are in Fast/Standard-mode):

- START condition (S)
- 8-bit master code (00001XXX)
- not-acknowledge bit (\bar{A})

The diagram below shows data flow of the Hs-mode.

After start condition, feed master code 00001XXX for transfer to the Hs-mode. And then AK09912 feeds back not-acknowledge bit and switch over to circuit for the Hs-mode between times t_1 and t_H . AK09912 can communicate at the Hs-mode from next START condition. At time t_{FS} , AK09912 switches its internal circuit from the Hs-mode to the First mode with the STOP condition (P). This transfer completes in the bus free time (t_{BUF}).

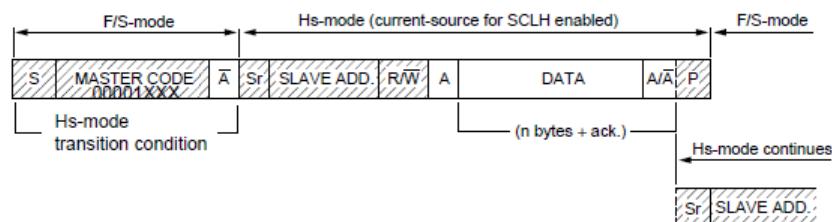


Figure 7.12 Data transfer format in Hs-mode

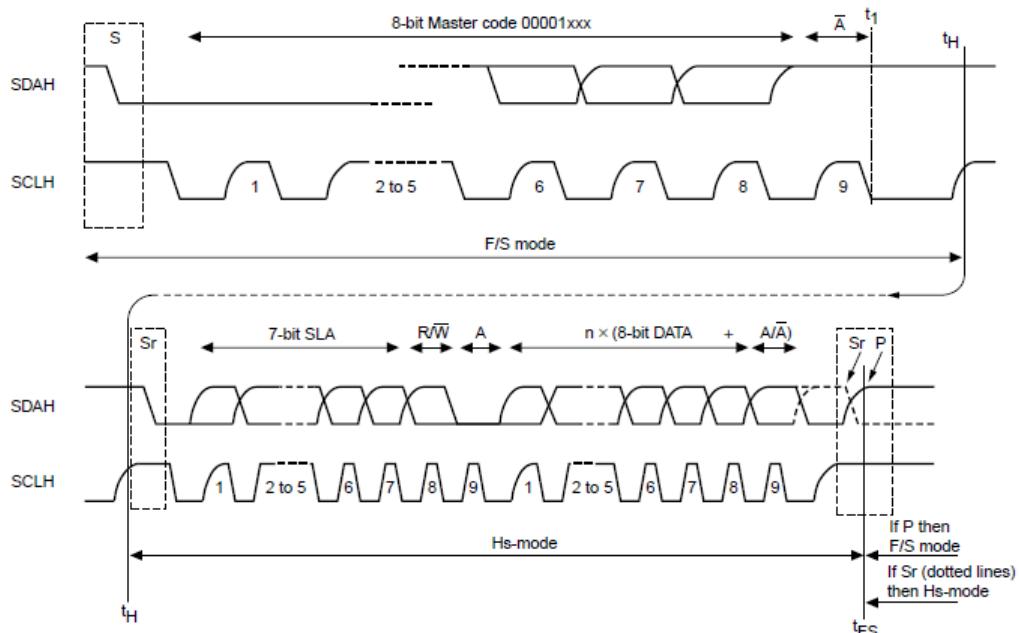


Figure 7.13 Hs-mode transfer

8. Registers

8.1. Description of Registers

AK09912 has registers of 24 addresses as indicated in Table 8.1. Every address consists of 8 bits data. Data is transferred to or received from the external CPU via the serial interface described previously.

Table 8.1 Register Table

Name	Address	READ/ WRITE	Description	Bit width	Remarks
WIA1	00H	READ	Company ID	8	
WIA2	01H	READ	Device ID	8	
RSV1	02H	READ	Reserved 1	8	
RSV2	03H	READ	Reserved 2	8	
ST1	10H	READ	Status 1	8	Data status
HXL	11H	READ	Measurement Magnetic Data	8	X-axis data
HXH	12H	READ		8	
HYL	13H	READ		8	Y-axis data
HYH	14H	READ		8	
HZL	15H	READ		8	Z-axis data
HZH	16H	READ		8	
TMPS	17H	READ	Measurement Temperature Data	8	Temperature data
ST2	18H	READ	Status 2	8	Data status
CNTL1	30H	READ/ WRITE	Control 1	8	Control settings
CNTL2	31H	READ/ WRITE	Control 2	8	Control settings
CNTL3	32H	READ/ WRITE	Control 3	8	Control settings
TS1	33H	READ/ WRITE	Test	8	DO NOT ACCESS
TS2	34H	READ/ WRITE	Test	8	DO NOT ACCESS
TS3	35H	READ/ WRITE	Test	8	DO NOT ACCESS
I2CDIS	36H	READ/ WRITE	I2C disable	8	
TS4	37H	READ/ WRITE	Test	8	DO NOT ACCESS
ASAX	60H	READ	X-axis sensitivity adjustment value	8	Fuse ROM
ASAY	61H	READ	Y-axis sensitivity adjustment value	8	Fuse ROM
ASAZ	62H	READ	Z-axis sensitivity adjustment value	8	Fuse ROM

Addresses 00H to 18H, 30H to 32H and 60H to 62H are compliant with automatic increment function of serial interface respectively. Values of addresses 60H to 62H can be read only in Fuse ROM access mode. In other modes, read data is not correct. When the address is in 00H to 18H, the address is incremented 00H → 01H → 02H → 03H → 10H → 11H ... → 18H, and the address goes back to 00H after 18H. When the address is in 30H to 32H, the address goes back to 30H after 32H. When the address is in 60H to 62H, the address goes back to 60H after 62H.

8.2. Register Map

Table 8.2 Register Map

Addr.	Register name	D7	D6	D5	D4	D3	D2	D1	D0
Read-only register									
00H	WIA1	0	1	0	0	1	0	0	0
01H	WIA2	0	0	0	0	0	1	0	0
02H	RSV1	RSV17	RSV16	RSV15	RSV14	RSV13	RSV12	RSV11	RSV10
03H	RSV2	RSV27	RSV26	RSV25	RSV24	RSV23	RSV22	RSV21	RSV20
10H	ST1	HSM	0	0	0	0	0	DO	DRDY
11H	HXL	HX7	HX6	HX5	HX4	HX3	HX2	HX1	HX0
12H	HXH	HX15	HX14	HX13	HX12	HX11	HX10	HX9	HX8
13H	HYL	HY7	HY6	HY5	HY4	HY3	HY2	HY1	HY0
14H	HYH	HY15	HY14	HY13	HY12	HY11	HY10	HY9	HY8
15H	HZL	HZ7	HZ6	HZ5	HZ4	HZ3	HZ2	HZ1	HZ0
16H	HZH	HZ15	HZ14	HZ13	HZ12	HZ11	HZ10	HZ9	HZ8
17H	TMPS	TMPS7	TMPS6	TMPS5	TMPS4	TMPS3	TMPS2	TMPS1	TMPS0
18H	ST2	0	0	0	0	HOFL	0	0	0
Read/Write register									
30H	CNTL1	TEM	NSF1	NSF0	0	0	0	0	0
31H	CNTL2	0	0	0	MODE4	MODE3	MODE2	MODE1	MODE0
32H	CNTL3	0	0	0	0	0	0	0	SRST
33H	TS1	-	-	-	-	-	-	-	-
34H	TS2	-	-	-	-	-	-	-	-
35H	TS3	-	-	-	-	-	-	-	-
36H	I2CDIS	I2CDIS7	I2CDIS6	I2CDIS5	I2CDIS4	I2CDIS3	I2CDIS2	I2CDIS1	I2CDIS0
37H	TS4	-	-	-	-	-	-	-	-
Read-only register									
60H	ASAX	COEFX7	COEFX6	COEFX5	COEFX4	COEFX3	COEFX2	COEFX1	COEFX0
61H	ASAY	COEFY7	COEFY6	COEFY5	COEFY4	COEFY3	COEFY2	COEFY1	COEFY0
62H	ASAZ	COEFZ7	COEFZ6	COEFZ5	COEFZ4	COEFZ3	COEFZ2	COEFZ1	COEFZ0

When VDD is turned ON, POR function works and all registers of AK09912 are initialized regardless of VID status. To write data to or to read data from register, VID must be ON.

TS1, TS2, TS3 and TS4 are test registers for shipment test. Do not use these registers.

8.3. Detailed of Description of Register

8.3.1. WIA: Who I Am

Addr.	Register name	D7	D6	D5	D4	D3	D2	D1	D0
Read-only register									
00H	WIA1	0	1	0	0	1	0	0	0
01H	WIA2	0	0	0	0	0	1	0	0

WIA1[7:0]: Company ID of AKM. It is described in one byte and fixed value.

48H: fixed

WIA2[7:0]: Device ID of AK09912. It is described in one byte and fixed value.

04H: fixed

8.3.2. RSV: Reserved

Addr.	Register name	D7	D6	D5	D4	D3	D2	D1	D0
Read-only register									
02H	RSV1	RSV17	RSV16	RSV15	RSV14	RSV13	RSV12	RSV11	RSV10
03H	RSV2	RSV27	RSV26	RSV25	RSV24	RSV23	RSV22	RSV21	RSV20

RSV1[7:0]/RSV2[7:0]: Device information of AKM.

8.3.3. ST1: Status 1

Addr.	Register name	D7	D6	D5	D4	D3	D2	D1	D0
Read-only register									
10H	ST1	HSM	0	0	0	0	0	DOR	DRDY
	Reset	0	0	0	0	0	0	0	0

DRDY: Data Ready

“0”: Normal

“1”: Data is ready

DRDY bit turns to “1” when data is ready in Single measurement mode, Continuous measurement mode 1, 2, 3, 4 , External trigger measurement mode or Self-test mode. It returns to “0” when any one of ST2 register or measurement data register (HXL to TMPS) is read.

DOR: Data Overrun

“0”: Normal

“1”: Data overrun

DOR bit turns to “1” when data has been skipped in Continuous measurement mode 1,2,3,4 or External trigger measurement mode. It returns to “0” when any one of ST2 register or measurement data register (HXL to TMPS) is read.

HSM: I²C Hs-mode

“0”: Standard/Fast mode

“1”: Hs-mode

HSM bit turns to “1” when I²C bus interface is changed from Standard or Fast mode to High-speed mode (Hs-mode).

8.3.4. HXL to HZH: Measurement Data

Addr.	Register name	D7	D6	D5	D4	D3	D2	D1	D0
Read-only register									
11H	HXL	HX7	HX6	HX5	HX4	HX3	HX2	HX1	HX0
12H	HXH	HX15	HX14	HX13	HX12	HX11	HX10	HX9	HX8
13H	HYL	HY7	HY6	HY5	HY4	HY3	HY2	HY1	HY0
14H	HYH	HY15	HY14	HY13	HY12	HY11	HY10	HY9	HY8
15H	HZL	HZ7	HZ6	HZ5	HZ4	HZ3	HZ2	HZ1	HZ0
16H	HZH	HZ15	HZ14	HZ13	HZ12	HZ11	HZ10	HZ9	HZ8
Reset		0	0	0	0	0	0	0	0

Measurement data of magnetic sensor X-axis/Y-axis/Z-axis

HXL[7:0]: X-axis measurement data lower 8-bit

HXH[15:8]: X-axis measurement data higher 8-bit

HYL[7:0]: Y-axis measurement data lower 8-bit

HYH[15:8]: Y-axis measurement data higher 8-bit

HZL[7:0]: Z-axis measurement data lower 8-bit

HZH[15:8]: Z-axis measurement data higher 8-bit

Measurement data is stored in two's complement and Little Endian format. Measurement range of each axis is -32752 to 32752 in 16-bit output.

Table 8.3 Measurement magnetic data format

Measurement data (each axis) [15:0]			Magnetic flux density [μ T]
Two's complement	Hex	Decimal	
0111 1111 1111 0000	7FF0	32752	4912(max.)
0000 0000 0000 0001	0001	1	0.15
0000 0000 0000 0000	0000	0	0
1111 1111 1111 1111	FFFF	-1	-0.15
1000 0000 0000 1000	8010	-32752	-4912(min.)

8.3.5. TMPS: Temperature Data

Addr.	Register name	D7	D6	D5	D4	D3	D2	D1	D0
Read-only register									
17H	TMPS	TMPS7	TMPS6	TMPS5	TMPS4	TMPS3	TMPS2	TMPS1	TMPS0
Reset		0	0	0	0	0	0	0	0

TMPS[7:0]: Measurement data of temperature sensor

$$\text{Temperature } [{}^{\circ}\text{C}] = 35 + (120 - \text{TMPS code}) / 1.6 \text{ [decimal value]}$$

- Temperature measuring range: -49.4°C (max code) to +110.0°C (minimum code)
- 49.4 °C or less : TMPS code = FF [hex value]
- +110.0 °C or more : TMPS code = 00 [hex value]

Table 8.4 Measurement temperature data format

Measurement data [7:0]	
Hex	Temperature [{}^{\circ}\text{C}]
FF	-49.4
81	29.4
80	30.0
7F	30.6
00	110.0

8.3.6. ST2: Status 2

Addr.	Register name	D7	D6	D5	D4	D3	D2	D1	D0
Read-only register									
18H	ST2	0	0	0	0	HOFL	0	0	0
Reset		0	0	0	0	0	0	0	0

HOFL: Magnetic sensor overflow

“0”: Normal

“1”: Magnetic sensor overflow occurred

In Single measurement mode, Continuous measurement mode 1, 2, 3, 4, External trigger measurement mode and Self-test mode, magnetic sensor may overflow even though measurement data register is not saturated. In this case, measurement data is not correct and HOFL bit turns to “1”. When next measurement starts, it returns to “0”. Refer to 6.4.3.6 for detailed information.

ST2 register has a role as data reading end register, also. When any of measurement data register (HXL to TMPS) is read in Continuous measurement mode 1, 2, 3, 4 or External trigger measurement mode, it means data reading start and taken as data reading until ST2 register is read. Therefore, when any of measurement data is read, be sure to read ST2 register at the end.

8.3.7. CNTL1: Control 1

Addr.	Register name	D7	D6	D5	D4	D3	D2	D1	D0
Read/Write register									
30H	CNTL1	TEM	NSF1	NSF0	0	0	0	0	0
Reset		0	0	0	0	0	0	0	0

TEM: Temperature measurement setting

“0”: disable

“1”: enable

When TEM bit is “1”, temperature sensor measurement is enabled. Temperature sensor is measured together with magnetic sensor. Refer to 6.5 for detailed information.

NSF[1:0]: Noise suppression filter setting

“00”: disable

“01”: Low

“10”: Middle

“11”: High

Output data from magnetic sensor is filtered to suppress the noise according to the setting. Refer to 6.6 for detailed information.

8.3.8. CNTL2: Control 2

Addr.	Register name	D7	D6	D5	D4	D3	D2	D1	D0
Read/Write register									
31H	CNTL2	0	0	0	MODE4	MODE3	MODE2	MODE1	MODE0
Reset		0	0	0	0	0	0	0	0

MODE[4:0]: Operation mode setting

“00000”: Power-down mode

“00001”: Single measurement mode

“00010”: Continuous measurement mode 1

“00100”: Continuous measurement mode 2

“00110”: Continuous measurement mode 3

“01000”: Continuous measurement mode 4

“01010”: External trigger measurement mode

“10000”: Self-test mode

“11111”: Fuse ROM access mode

Other code settings are prohibited.

When each mode is set, AK09912 transits to the set mode. Refer to 6.3 for detailed information.

8.3.9. CNTL3: Control 3

Addr.	Register name	D7	D6	D5	D4	D3	D2	D1	D0
Read/Write register									
32H	CNTL3	0	0	0	0	0	0	0	SRST
Reset		0	0	0	0	0	0	0	0

SRST: Soft reset

“0”: Normal

“1”: Reset

When “1” is set, all registers (without ASAX, ASAY and ASAZ) are initialized. After reset, SRST bit turns to “0” automatically.

8.3.10. TS1, TS2, TS3: Test

Addr.	Register name	D7	D6	D5	D4	D3	D2	D1	D0
Read/Write register									
33H	TS1	-	-	-	-	-	-	-	-
34H	TS2	-	-	-	-	-	-	-	-
35H	TS3	-	-	-	-	-	-	-	-
Reset		0	0	0	0	0	0	0	0

TS1, TS2 and TS3 registers are AKM internal test registers. Do not use these registers.

8.3.11. I2CDIS: I²C Disable

Addr.	Register name	D7	D6	D5	D4	D3	D2	D1	D0
Read/Write register									
36H	I2CDIS	I2CDIS7	I2CDIS0						
Reset		0	0	0	0	0	0	0	0

This register disables I²C bus interface. I²C bus interface is enabled in default. To disable I²C bus interface, write “00011011” to I2CDIS register. Then I²C bus interface is disabled.

Once I²C bus interface is disabled, it is impossible to write other value to I2CDIS register. To enable I²C bus interface, reset AK09912 or input start condition 8 times continuously.

8.3.12. TS4: Test 4

Addr.	Register name	D7	D6	D5	D4	D3	D2	D1	D0
Read/Write register									
37H	TS4	-	-	-	-	-	-	-	-
Reset		0	1	1	0	1	0	0	1

TS4 registers are test registers for shipment test. Do not use this registers.

8.3.13. ASAX, ASAY, ASAZ: Sensitivity Adjustment Values

Addr.	Register name	D7	D6	D5	D4	D3	D2	D1	D0
Read-only register									
60H	ASAX	COEFX7	COEFX6	COEFX5	COEFX4	COEFX3	COEFX2	COEFX1	COEFX0
61H	ASAY	COEFY7	COEFY6	COEFY5	COEFY4	COEFY3	COEFY2	COEFY1	COEFY0
62H	ASAZ	COEFZ7	COEFZ6	COEFZ5	COEFZ4	COEFZ3	COEFZ2	COEFZ1	COEFZ0

Sensitivity adjustment data for each axis is stored to Fuse ROM on shipment.

ASAX[7:0]:Magnetic sensor X-axis sensitivity adjustment value

ASAY[7:0]:Magnetic sensor Y-axis sensitivity adjustment value

ASAZ[7:0]:Magnetic sensor Z-axis sensitivity adjustment value

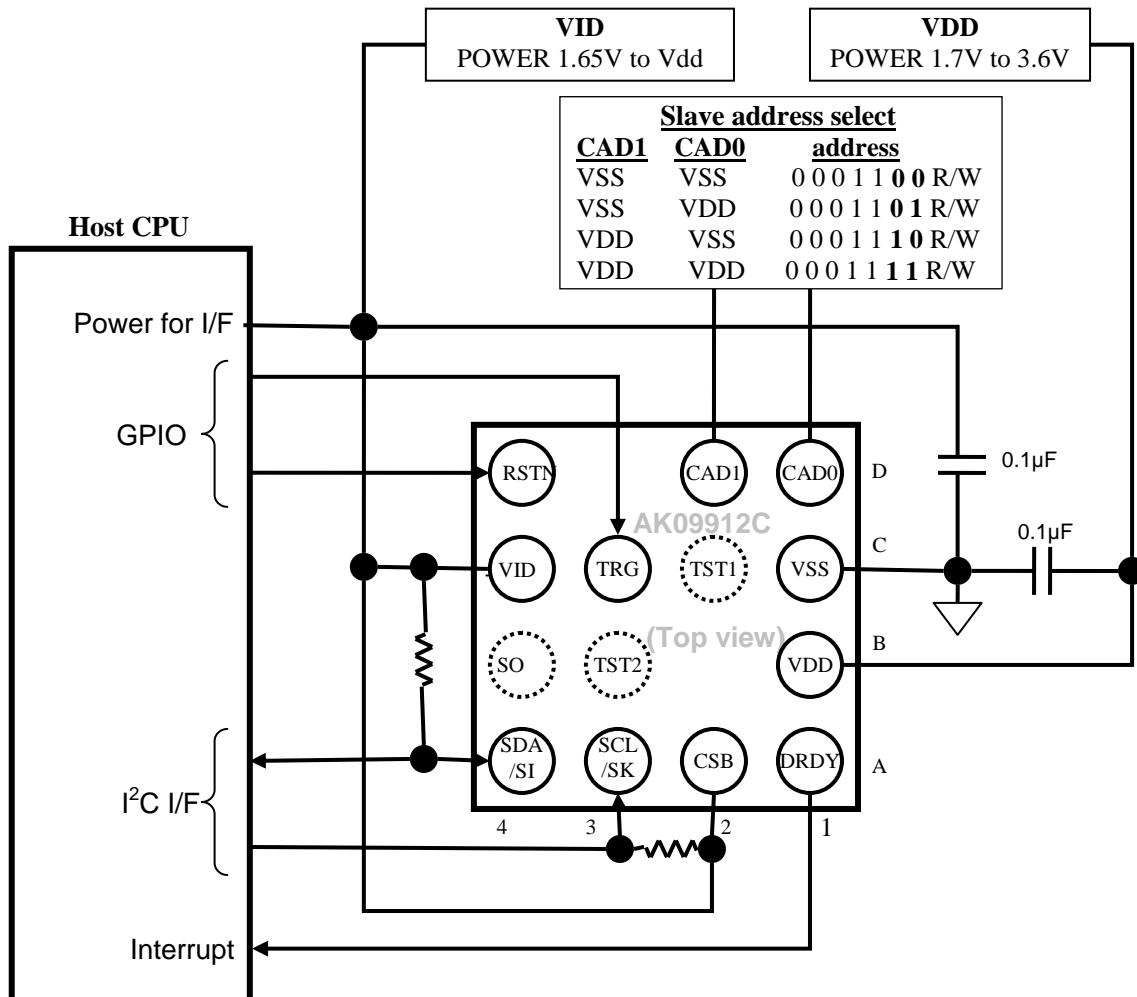
How to adjust sensitivity

The sensitivity adjustment is done by the equation below, where *H* is the measurement data read out from the measurement data register, *ASA* is the sensitivity adjustment value and *Hadj* is the adjusted measurement data.

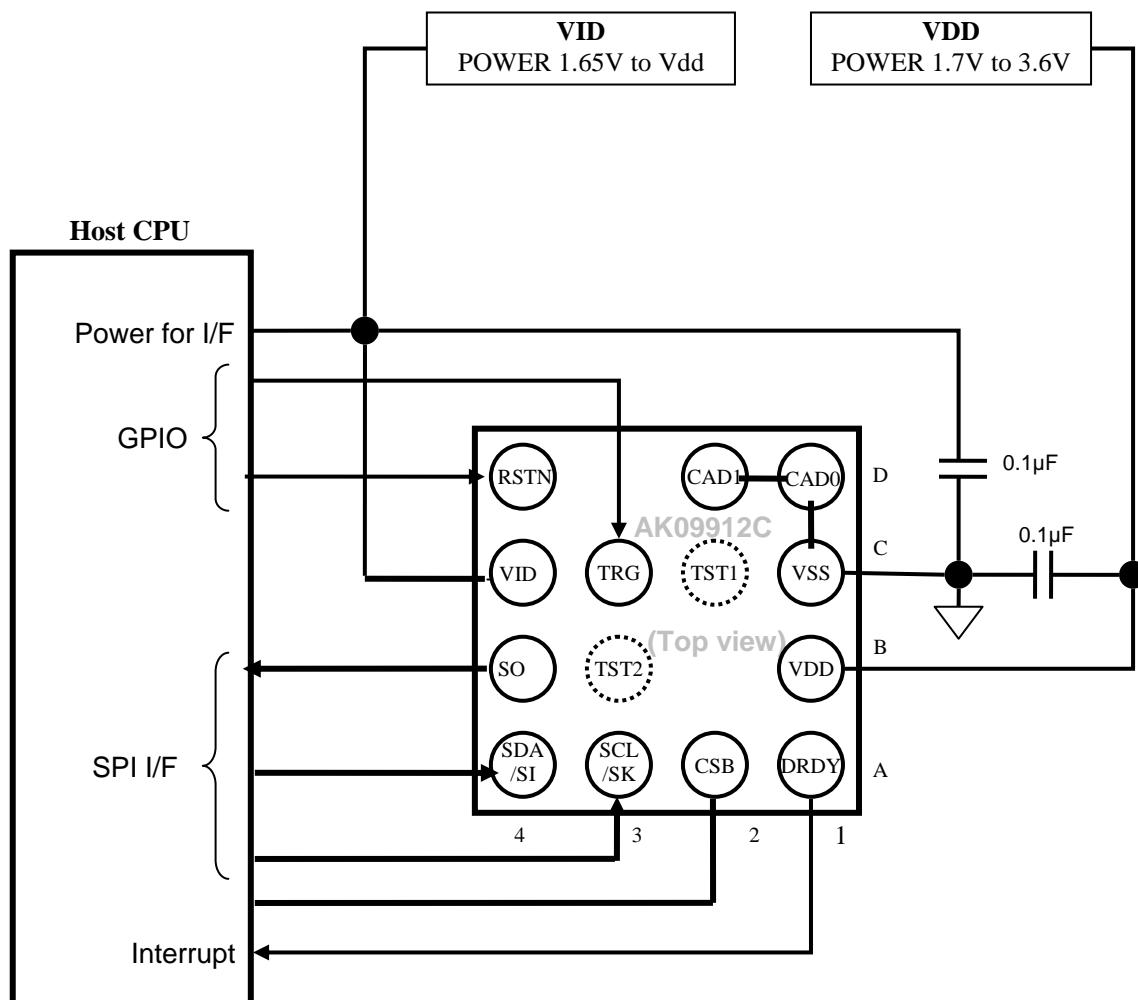
$$Hadj = H \times \left(\frac{(ASA - 128) \times 0.5}{128} + 1 \right)$$

9. Example of Recommended External Connection

9.1. I²C Bus Interface



Pins of dot circle should be kept non-connected.

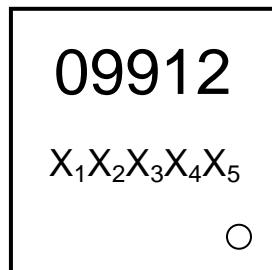


Pins of dot circle should be kept non-connected.

10. Package

10.1. Marking

- Product name: 09912
- Date code: $X_1X_2X_3X_4X_5$
 - X_1 = ID
 - X_2 = Year code
 - X_3X_4 = Week code
 - X_5 = Lot



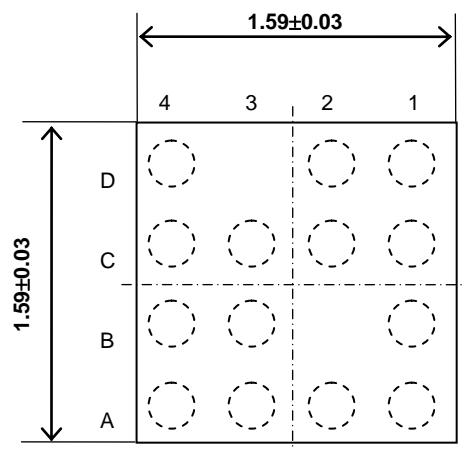
<Top view>

10.2. Pin Assignment

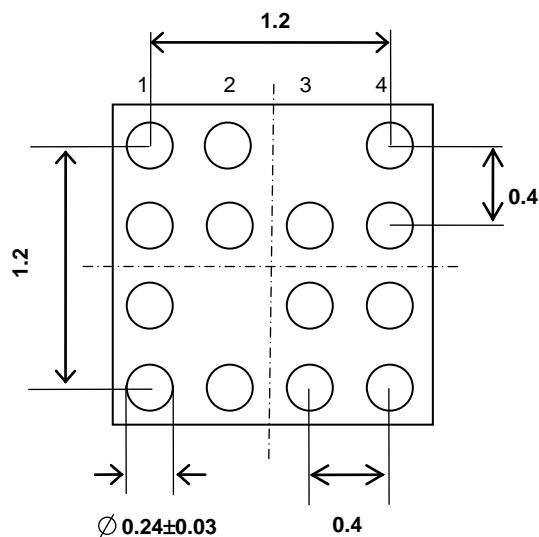
	4	3	2	1
D	RSTN		CAD1	CAD0
C	VID	TRG	TST1	VSS
B	SO	TST2		VDD
A	SDA/SI	SCL/SK	CSB	DRDY

<Top view>

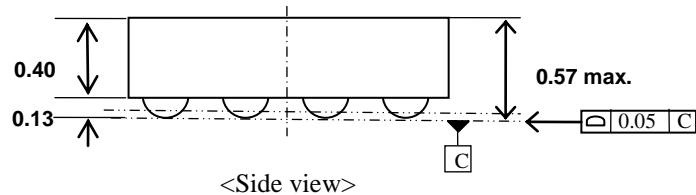
10.3. Outline Dimensions



<Top view>

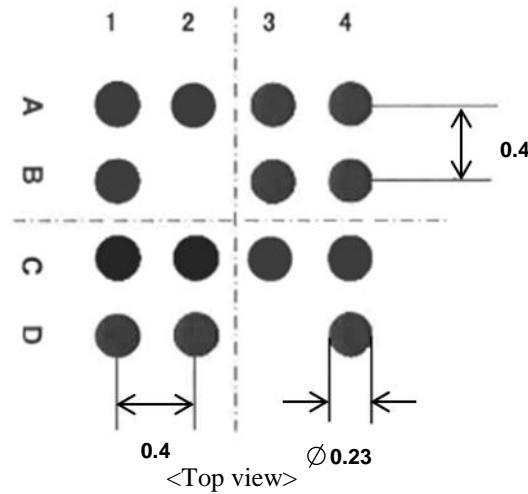


<Bottom view>



<Side view>

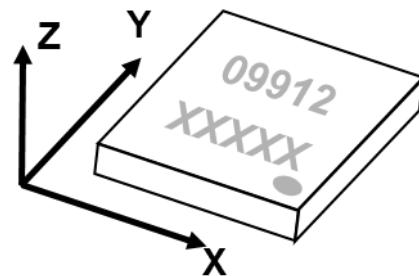
10.4. Recommended Foot Print Pattern



<Top view>

11. Relationship between the Magnetic Field and Output Code

The measurement data increases as the magnetic flux density increases in the arrow directions.



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